

Mini-Circuits

SURFACE MOUNT



RF Transformer

TCM1-382WX+

50Ω 0.5 to 3800 MHz

THE BIG DEAL

- Wideband, 0.5 to 3800 MHz
- Flat Response, ± 0.6 dB Insertion Loss Over Full Band
- Aqueous Washable
- Protected by US Patent 9,071,229B1



Generic photo used for illustration purposes only

CASE STYLE: DB1627

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Differential Modulator/Demodulators and Active Mixers
- Wideband Push-Pull Amplifiers

PRODUCT OVERVIEW

Mini-Circuits' TCM1-382WX+ is a surface-mount, transmission line, core and wire transformer covering a very wide frequency range, specified from 0.5 to 3800 MHz and usable from 0.2 to 3800 MHz. The transformer provides a 1:1 impedance ratio with low insertion loss, excellent flatness, as well as low phase and amplitude unbalance. Featuring core and wire construction on a 6-lead plastic base with tin over nickel termination finish. The unit measures 0.16x0.15x0.16" accommodating dense circuit board layouts. It also incorporates the Mini-Circuits' Top Hat® feature for faster, more accurate pick-and-place assembly and easy visual inspection.

KEY FEATURES

Feature	Advantages
Wideband 0.5 to 3800 MHz	Very wide frequency range covers bandwidth requirements for many applications.
Low Loss 1.94 dB, 0.5 to 3800 MHz	Provide excellent signal transmission from input to output with consistent performance.
Small Footprint 0.16x0.15x0.16"	Accommodates tight space requirements for dense PCB layout.
Top Hat® Feature	Improves speed and accuracy of pick & place assembly and provides clear device marking for visual inspection.

REV. OR
ECO-012619
TCM1-382WX+
MCL NY
251120





RF Transformer

TCM1-382WX+

50Ω 0.5 to 3800 MHz

ELECTRICAL SPECIFICATIONS¹ AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Impedance Ratio			1		
Frequency Range		0.5		3800	MHz
Insertion Loss	10-2000		1.1	2.0	dB
	0.5-3800		1.9	3.0	
Amplitude Unbalance	0.5-2000		0.5		dB
	2000-3800		1.2		
Phase Unbalance	0.5-3000		4		Degree
	3000-3800		6		
Return Loss	0.5-3800		12		dB

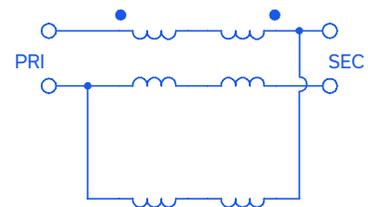
1. Measured on Mini-Circuits Characterization test board TB-TCM1-382WX+ with test board loss deducted.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	0.2 W
DC Current	30 mA

Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION K





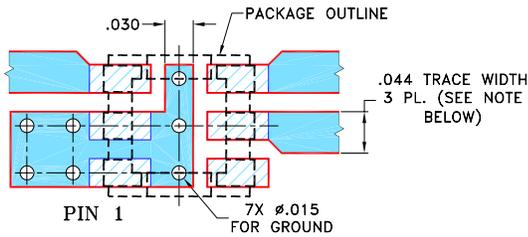
PIN CONNECTIONS²

PRIMARY DOT	3
PRIMARY	2
SECONDARY DOT	5
SECONDARY	4
GND	1,2
NOT USED	6

2. We recommend grounding the primary (Pin 2) as shown in PL-395.

PRODUCT MARKING: YM

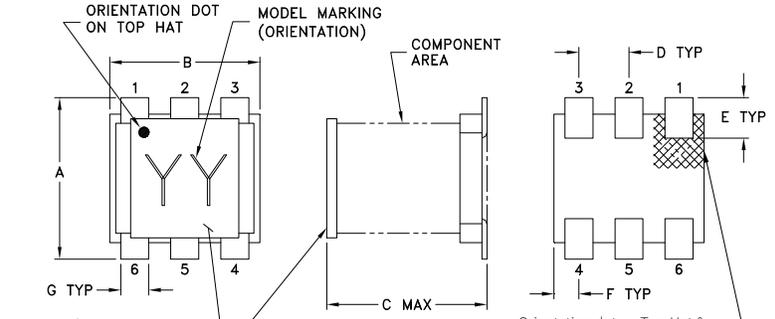
DEMO BOARD MCL P/N: TB-TCM1-382WX+ SUGGESTED PCB LAYOUT (PL-395)



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

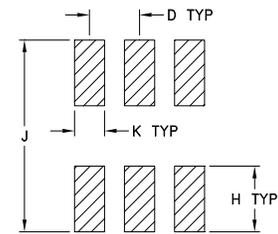
OUTLINE DRAWING



TOP-HAT / PICK & PLACE SURFACE AREA (.10X.10) MIN
TOP-HAT TOTAL THICKNESS: .013 inches MAX.

Orientation dot on Top-Hat & orientation feature on substrate corresponds to pin #1.

PCB Land Pattern

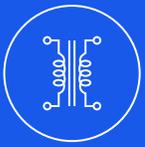


SUGGESTED LAYOUT
TOLERANCE TO BE WITHIN ±.002

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

TAPE & REEL INFORMATION: F47



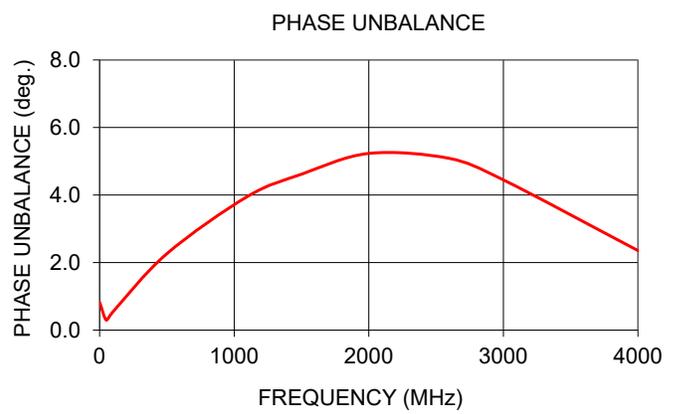
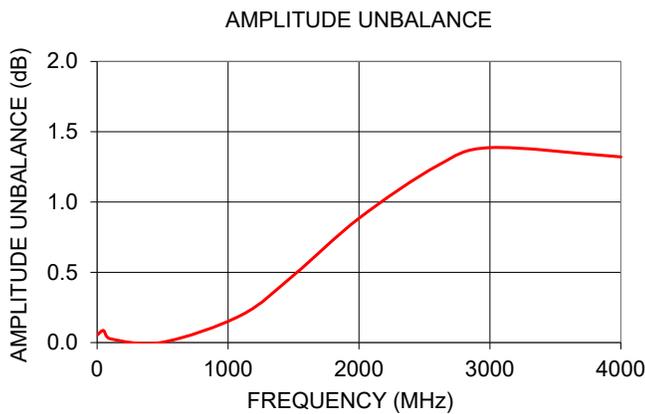
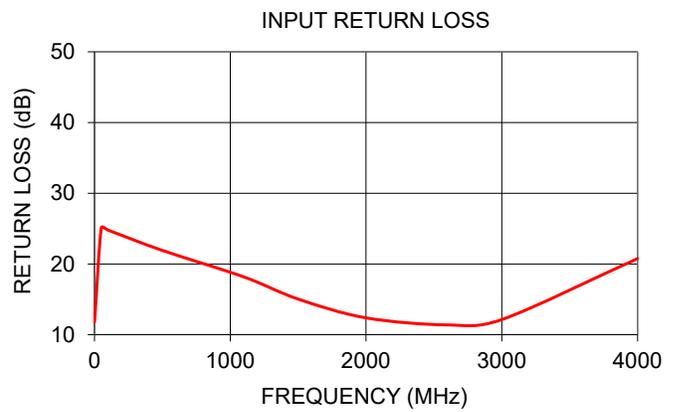
RF Transformer

TCM1-382WX+

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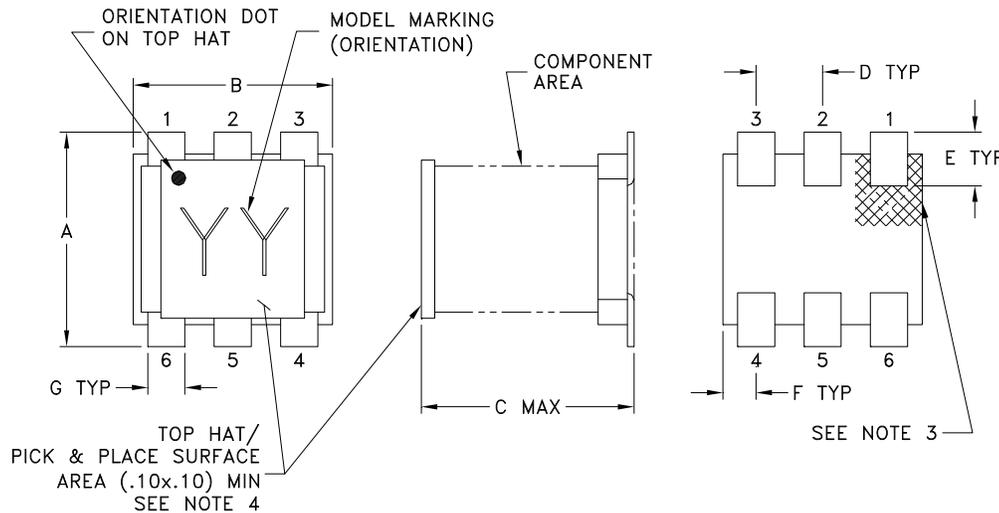
TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
0.5	1.73	11.77	0.05	0.82
50.0	0.75	25.07	0.09	0.29
100.0	0.72	24.78	0.03	0.55
500.0	0.72	21.92	0.00	2.26
1100.0	0.83	18.17	0.19	3.96
1500.0	0.96	15.04	0.48	4.62
2000.0	1.22	12.38	0.88	5.23
2600.0	1.56	11.38	1.26	5.08
3000.0	1.69	12.14	1.39	4.45
3800.0	1.94	19.64	1.36	0.55

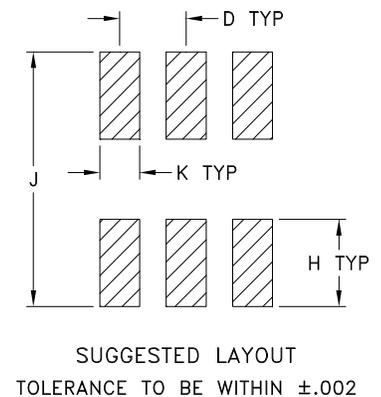


- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Outline Dimensions



PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB1627	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

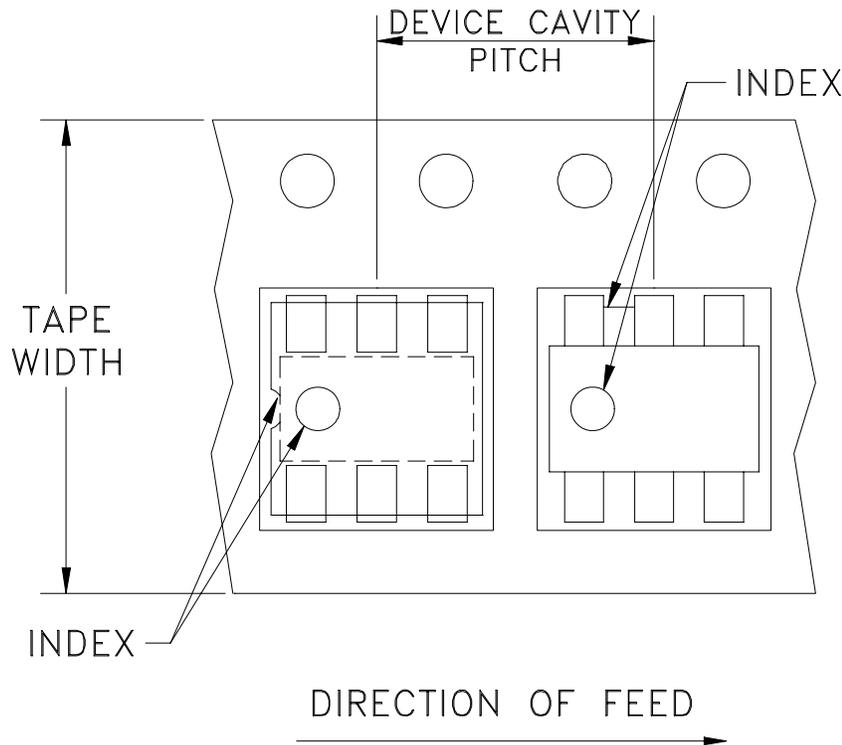
Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Orientation dot on top hat & orientation feature on substrate correspondence to pin #1.
- Top-Hat total thickness: .013 inches MAX.

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



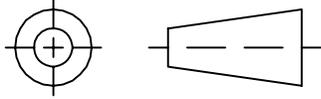
INTERNET <http://www.minicircuits.com>

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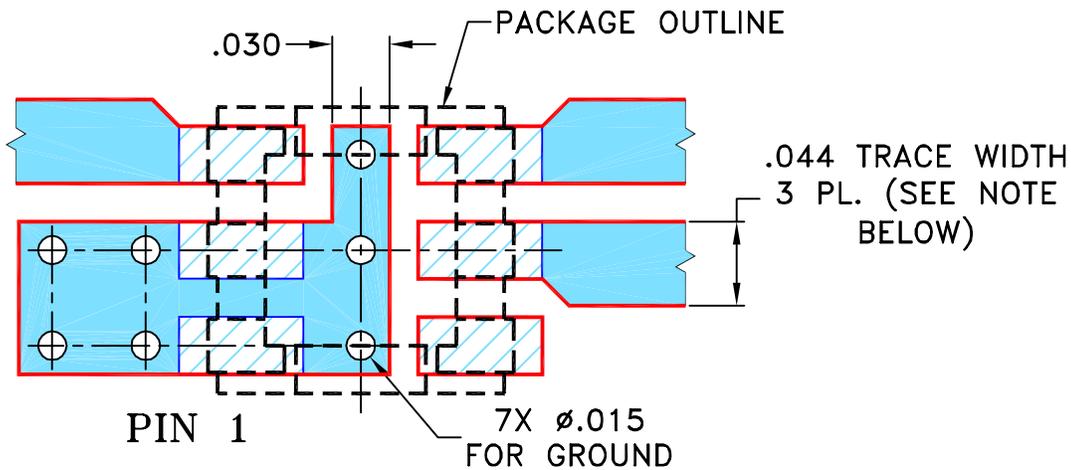
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M141791	NEW RELEASE	06/14/13	AV	DJ

SUGGESTED MOUNTING CONFIGURATION
FOR DB1627 CASE STYLE, "06TK03" PIN CODE



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DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	AV 06/03/13
	CHECKED	IL 06/14/13
	APPROVED	DJ 06/14/13

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 Brooklyn NY 11235

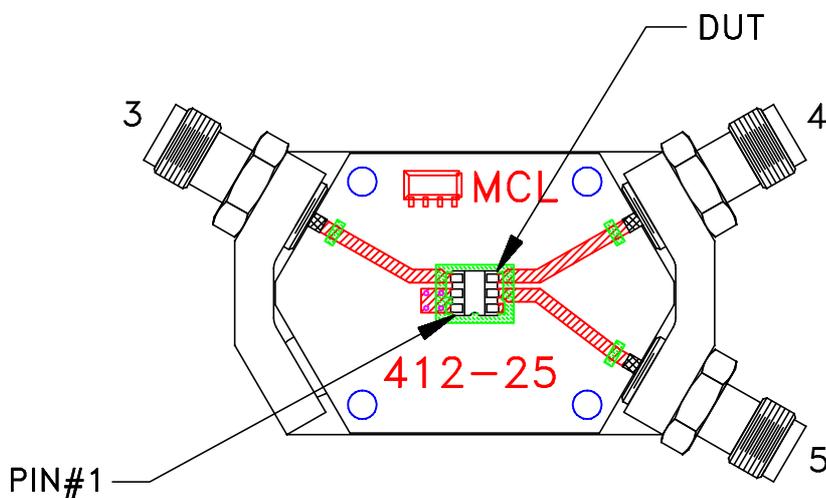
PL, 06TK03, DB1627, TB-717+

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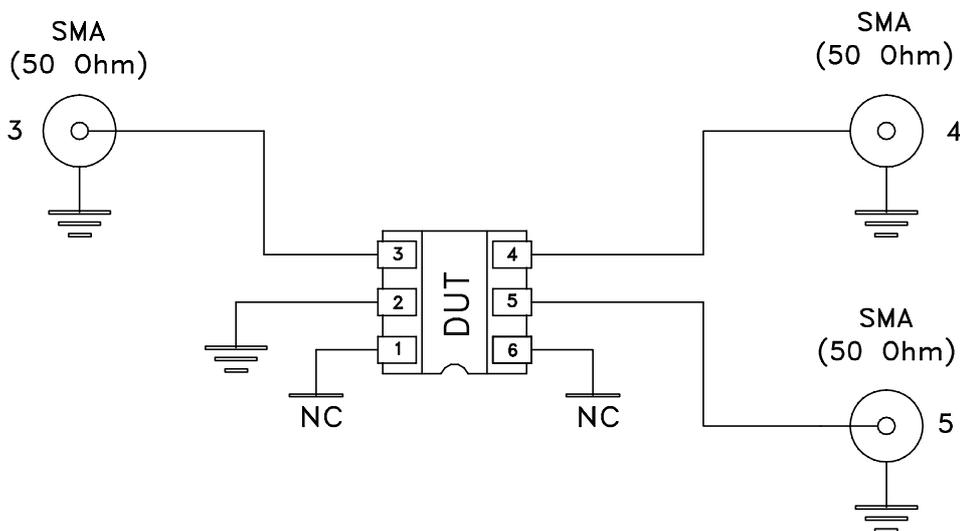
SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-395	REV: OR
FILE: 98PL395	SCALE: 10:1	SHEET: 1 OF 1	

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-TCM1-382WX+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215